Yufan DENG

Education _____

Hong Kong University of Science and Technology (HKUST) BENG in CS, CGPA 4.19/4.30 École Polytechnique Fédérale de Lausanne (EPFL) Exchange **Shenzhen Middle School (SMS)** High School, GPA 4.32/4.45

Technical Skills

Programming Language Python (Skilled), Java (Skilled), C++ (Skilled), PHP (Basic), SQL (Basic), C (Basic) Deep Learning Toolkits Pytorch, Hugging Face Libraries Miscellaneous LaTeX, Linux, Git, Matlab, MS Office, Adobe Languages Mandarin (Native), English (Proficient)

Publications _____

[1] Yufan Deng*, Ruida Wang*, Yuhao Zhang*, et al. "DragVideo: Interactive Drag-style Video Editing," ECCV, 2024. [Link]

Research Experiences _____

 "Learning 3D Object Rigging" Advisers: Prof. Jiajun Wu (Stanford), Shangzhe Wu (Stanford), Geng Chen (Stanford) Focus: Auto-Rigging 	<i>California, US</i> June 2024 - Current
 *DragVideo: Interactive Drag-style Video Editing" [Link] Advisers: Prof. Chi-Keung Tang (HKUST), Prof. Yu-Wing Tai (Dartmouth) Focus: Temporal Consistence, Point-based edit, Video Diffusion Model 	<i>Hong Kong</i> July 2023 - Nov. 2023
 *Deep Learning for Medical Images Advisors: Prof. Hao Chen (HKUST) Focus: Synthetic Data Augmentation, Multi-task Model, Quality-aware Model 	<i>Hong Kong</i> June 2022 - May 2023

Awards and Honors _____

Sep. 2022-2025	Scholarship: "HKSAR Government Scholarship" (80000 HKD per year)	Hong Kong
May 2024	Scholarship: "Tin Ka Ping Scholarship (Exchange)" (20000 HKD)	Lausanne
Sep. 2023	Scholarship: "HKUST Alumni Endowment Fund High Flyers Program Scholarship" (10000 HKD)	Hong Kong
Aug. 2023	Scholarship: "Tse Cheuk Ng Tai Scholarship" (10000 HKD)	Hong Kong
Jan. 2022-2024	Honorary Title: "Dean's List" for 5 semesters (TGA 3.7 or above, top 10 percentile)	Hong Kong
Dec. 2020	Contest: First Runner-Up in "2020 Tencent Rhino-Bird High School Elite Training Program"	Shenzhen

Working Experiences _____

Research Assistant

Assist AIGC project in Visual Intelligence Lab, HKUST

Teaching Assistant

Prepare lab assignments for COMP2211 (Exploring Artificial Intelligence)

Mar. 2024 - June 2024

Hong Kong July 2023 - Aug. 2023

Hong Kong Sep. 2021 - Current Lausanne, Switzerland Feb. 2024 - June 2024 Shenzhen, China Sep. 2018 - June 2021

Remote